CRMCTH1510A

N-Channel 150V,9.2mΩ Typ. Power MOSFET

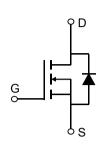
Description

Features

• 150V, 100A

 $R_{DS(ON)}$ Typ = 9.2m Ω @ V_{GS} = 10V Advanced Trench Technology

- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





CTH1510A 17 (1) CRM XXX XXXXX G D S

Marking and Pin Assignment

Application

- Load Switch
- PWM Application
- Power Management

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCTH1510A	CRMCTH1510A	TO-220C-3L	TUBE	50	1000	5000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		150	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	100	Α
I _D		T _C = 100°C	60	Α
I _{DM}	Pulsed Drain Current ⁽¹⁾		400	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		518	mJ
P_{D}	Power Dissipation	T _C = 25°C	240	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		0.52	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 150V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Char	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	9.2	12	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	12671	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	606	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112	X -\	553	-	pF
Q _g	Total Gate Charge		-	295	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 75V, I_{D} = 20A$) .	46.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 73V, I _D -20A	-	90	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	33	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 75V$	-	28	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 20A, R_{GEN} = 2.5\Omega$	-	108	-	ns
t_f	Turn-Off Fall Time		-	45	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	100	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	400	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I - 504 dildt - 4004/	-	52	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 50A$, di/dt = 100A/us	-	180	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=45.5A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

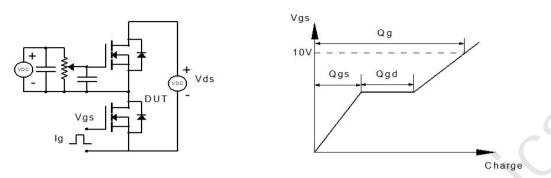


Figure 1: Gate Charge Test Circuit & Waveform

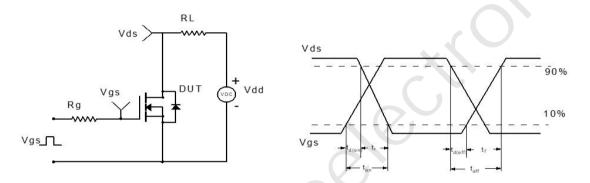


Figure 2: Resistive Switching Test Circuit & Waveform

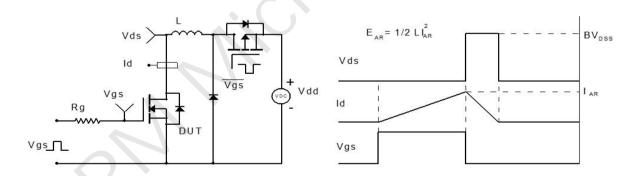


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

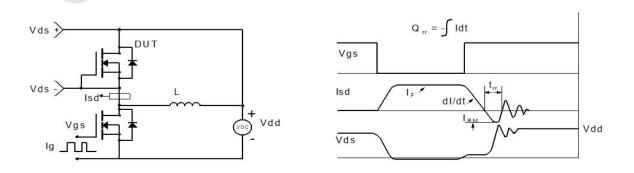
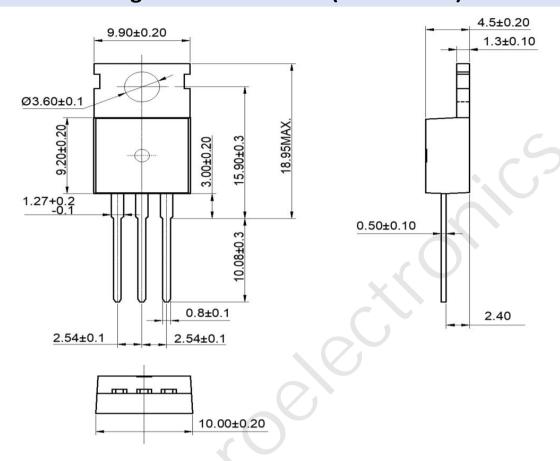


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-220C-3L)



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